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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
09/884,670	06/19/2001	Stephen R. Fox	YOR920010104(14270)	4482
7.	590 11/30/200		EXAMINER	
Steven Fischn	nan Esq.		POMPEY, RO	ON EVERETT
	urphy and Presser		ABTIBUT	DADED MUDADED
400 Garden Cit	y Plaza		ART UNIT	PAPER NUMBER
Garde City, NY 11530			2812	

DATE MAILED: 11/30/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)	
	09/884,670	FOX ET AL.	
Office Action Summary	Examiner	Art Unit	
	Ron E Pompey	2812	
The MAILING DATE of this communication Period for Reply	on appears on the cover sheet wi	h the correspondence address	
A SHORTENED STATUTORY PERIOD FOR F THE MAILING DATE OF THIS COMMUNICAT - Extensions of time may be available under the provisions of 37 of after SIX (6) MONTHS from the mailing date of this communicat - If the period for reply specified above is less than thirty (30) days - If NO period for reply is specified above, the maximum statutory - Failure to reply within the set or extended period for reply will, by Any reply received by the Office later than three months after the earned patent term adjustment. See 37 CFR 1.704(b).	TION. CFR 1.136(a). In no event, however, may a retion. s, a reply within the statutory minimum of thirty period will apply and will expire SIX (6) MON by statute, cause the application to become AB	eply be timely filed (30) days will be considered timely. FHS from the mailing date of this communication ANDONED (35 U.S.C. § 133).	i. ,
Status			
1) Responsive to communication(s) filed on	23 August 2004.		
2a)⊠ This action is FINAL. 2b)□	This action is non-final.		
 Since this application is in condition for a closed in accordance with the practice un 	•	*	ı
Disposition of Claims			
4) Claim(s) 1,3-22,25-36,40,48,49,51 and 5 4a) Of the above claim(s) is/are wi 5) Claim(s) is/are allowed. 6) Claim(s) 1, 3-22, 25-36, 40 and 48, 49 and 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction Application Papers 9) The specification is objected to by the Extended to be subjected to be subjected to by the Extended to be subjected to be subjected to by the Extended to be subjected to be	ithdrawn from consideration. and 51-52 is/are rejected. and/or election requirement. aminer. accepted or b) objected to be to the drawing(s) be held in abeyan correction is required if the drawing(s)	by the Examiner. ce. See 37 CFR 1.85(a). s) is objected to. See 37 CFR 1.121(d	i).
Priority under 35 U.S.C. § 119	o Examinor, recto the attached		
12) Acknowledgment is made of a claim for for a) All b) Some * c) None of: 1. Certified copies of the priority docu 2. Certified copies of the priority docu 3. Copies of the certified copies of the application from the International E * See the attached detailed Office action for	uments have been received. uments have been received in A e priority documents have been Bureau (PCT Rule 17.2(a)).	pplication No received in this National Stage	
Attachment(s)	_		
 Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO-9-3) Information Disclosure Statement(s) (PTO-1449 or PTO/Paper No(s)/Mail Date 	48) Paper No(s	ummary (PTO-413))/Mail Date formal Patent Application (PTO-152) 	

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DETAILED ACTION

Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- Claims 1, 3-22, 25-36, 40 and 48, 49 and 51-52 are rejected under 35 U.S.C.
 103(a) as being unpatentable over Sadana et al. (US 6,090,689) in further view of
 Tachimori et al. (US 5,534,446), Sadana et al. (US 5,930,643) and admitted prior art.
 Sadana ('689) discloses the steps of:

For claims 1-22 and 25-29:

implanting oxygen ions (14, 18, fig. 2) into a surface of a Si-containing substrate, said implanted oxygen ions having a concentration sufficient to form a buried oxide region during a subsequent annealing step; and

annealing said substrate wherein, said implanted oxygen ions form said buried oxide region (22, fig. 3) (col. 3, lns. 6-12 and col. 4, ln. 8 – col. 5, ln. 34).

Sadana ('689) discloses the claimed invention except for:

wherein the annealing step is carried out in an ambient gas comprising at least one high-surface mobility gas that hinders oxide growth;

wherein the annealing step comprises the steps of: partially annealing the substrate so as to form a surface layer of oxygen on the substrate; stripping the surface

layer of oxygen; and continuing the annealing to complete the formation of said BOX region; and

optically detecting said other defects.

However, Tachimori teaches an annealing step is carried out in an ambient gas comprising at least one high-surface mobility gas that hinders oxide growth (col. 7, In. 55 – col.8, In.5) and Sadana('643) teaches partially annealing the substrate so as to form a surface layer of oxygen on the substrate; stripping the surface layer of oxygen; and continuing the annealing to complete the formation of said BOX region (col. 5, Ins. 22-43).

Therefore it would have been obvious to those of ordinary skill in the art to combine Tachimori and Sadana ('643) because, the high-surface mobility gas will prevent the semiconductor surface from roughening and that the oxide is of poor quality and needs to be removed before forming a device on the SOI substrate.

Also the admitted prior art (see page 3, lines 1-4) disclose is it well known in the art to use an optical inspection tool to inspect process induced features or defects.

Response to Arguments

3. Applicant's arguments filed 8-23-04, pertaining to claims 1, 3-22, 25-36, 40 and 48, 49 and 51-52, have been fully considered but they are not persuasive. The applicant argues that "...none of the prior art methods teach or suggest a method in which annealing is carried out until tile or divot defects present at a top surface of said superficial Si-containing layer are reduced so as to allow optical detection of any other

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defect that has a lower density than the tile or divot defect, and then optically detecting said other defects."

However, since the prior art reads on the **claimed** parameters used to anneal an oxygen-implanted substrate the same results will be achieved as applicants **claimed** invention.

The applicant argues that Sadana '689 first annealing step is performed at lower temperatures than presently claimed. This statement is correct. However, applicant fails to acknowledge an anneal, subsequent to the first anneal, that is performed "...above 1100°C and below melting (1420 °C or Si)", see Sadana '689 column 5, lines 18-19. Therefore this subsequent anneal does read on the claimed high temperature (of about 1250°C or greater) anneal.

The Tachimori reference, according to the applicant uses a single implant and a normal O₂ pressure anneal which does not help the deficiencies of Sadana '689. The examiner would like to point out that the Tachimori reference was used to disclose annealing step, after oxygen implantation, in an ambient gas comprising an inert carrier. The applicant presents no arguments pertaining to why the Tachimori reference does not disclose these limitations; therefore the examiner will take this as an affirmation that the Tachimori reference reads on those limitations.

The Sadana '643 reference, according to the applicant does not teach or suggest which ambient can be used to reduce tile or divot defects in the SOI layer. First, the examiner would like to point out that the Sadana '643 reference was used to teach partially annealing the substrate so as to form a surface layer of oxygen on the

substrate; stripping the surface layer of oxygen; and continuing the annealing to complete the formation of said BOX region (col. 5, Ins. 22-43). Since the applicant presents no arguments pertaining to why the Sadana '643 reference does not disclose these limitations, therefore the examiner will take this as an affirmation that the Tachimori reference reads on those limitations. Secondly, the Sadana '643 reference does disclose ambients that are enclosed within the range as claimed by applicant therefore will have the same result as the claimed invention, reduced tile or divot defects. From the examiner's standpoint a range of values means that using any value within that range will give you the desired result.

Conclusion

4. **THIS ACTION IS MADE FINAL.** Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

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Any inquiry concerning this communication or earlier communications from the examiner should be directed to Ron E Pompey whose telephone number is (571) 272-1680.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, John Niebling can be reached on (571) 272-1679.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Ron Pompey

AU:2812

November 27, 2004

John F. Niebling

Supervisory Patent Exeminar Technology Center 2800